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Silicon N-Channel MOS FET



ADE-208-1346 (Z) 1st. Edition Mar. 2001

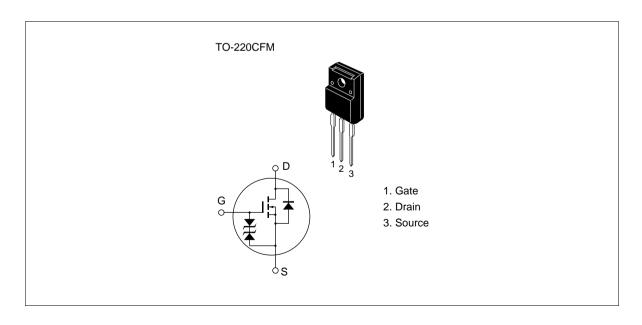
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for Switching regulator

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK2114	V _{DSS}	450	V
	2SK2115	V _{DSS}	500	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	5	А
Drain peak current		l _{D(pulse)} *1	20	А
Body to drain diode reverse drain current		I _{DR}	5	Α
Channel dissipation		Pch*2	35	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Notes 1. PW 10 µs, duty cycle 1 %

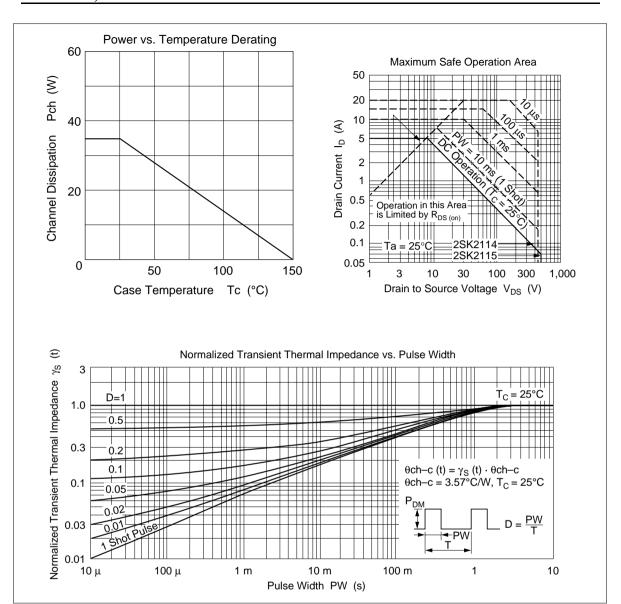
2. Value at Tc = 25 °C

Electrical Characteristics ($Ta = 25^{\circ}C$)

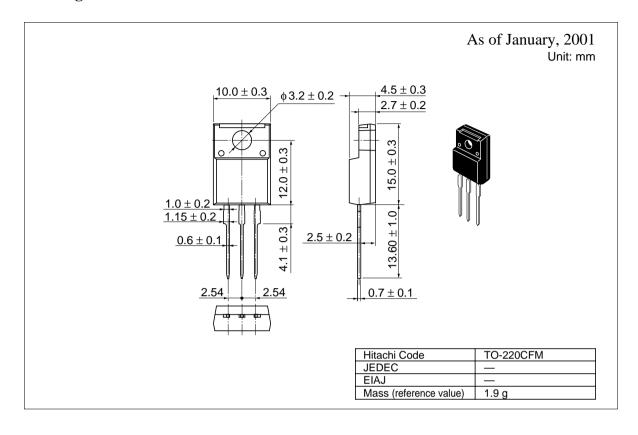
	Symbol	Min	Тур	Max	Unit	Test conditions
2SK2114	$V_{(BR)DSS}$	450	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
2SK2115	_	500				
eakdown	$V_{(BR)GSS}$	±30	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
ak current	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
2SK2114	I _{DSS}	_	_	250	μA	$V_{DS} = 360 \text{ V}, V_{GS} = 0$
2SK2115						$V_{DS} = 400 \text{ V}, V_{GS} = 0$
toff voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
2SK2114	R _{DS(on)}	_	1.0	1.4		$I_D = 2.5 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
2SK2115	_	_	1.2	1.5		
admittance	y _{fs}	2.5	4.0	_	S	$I_D = 2.5 \text{ A}$ $V_{DS} = 10 \text{ V}^{*1}$
ı	Ciss	_	640	_	pF	V _{DS} = 10 V
се	Coss	_	160	_	pF	$V_{GS} = 0$
capacitance	Crss	_	20	_	pF	f = 1 MHz
е	t _{d(on)}	_	10	_	ns	I _D = 2.5 A
	t _r	_	25	_	ns	V _{GS} = 10 V
е	t _{d(off)}		50		ns	R _L = 12
	t _f	_	30	_	ns	
de forward	V_{DF}	_	0.95	_	V	$I_F = 5 \text{ A}, V_{GS} = 0$
de reverse	t _{rr}	_	300	_	ns	$I_F = 5 \text{ A}, V_{GS} = 0,$ $di_F / dt = 100 \text{ A} / \mu \text{s}$
	2SK2115 eakdown ak current 2SK2114 2SK2115 etoff voltage 2SK2114 2SK2115 admittance ce capacitance e	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	2SK2114	2SK2114	2SK2114 V _{(BR)DSS} 450 — V eakdown V _{(BR)GSS} ±30 — V ak current I _{GSS} — ±10 μA 2SK2114 I _{DSS} — 250 μA 2SK2115

Note 1. Pulse Test

See characteristics curve of 2SK1155, 2SK1156.



Package Dimensions



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